CLAIMS

- 1. A die cleaning method for removing a formingmaterial from a die used in forming the forming-material
 containing a binder, characterized by comprising the steps
 of: removing a part or all of the binder contained in the
 forming-material from the die; and removing the formingmaterial from the die.
- 2. The die cleaning method according to claim 1, wherein the step of removing a part or all of the binder is performed by heating the die.
 - 3. The die cleaning method according to claim 2, wherein a heating temperature is in a range of 200 to 500°C.
 - 4. The die cleaning method according to any one of claims 1 to 3, wherein the step of removing the forming-material is performed by spraying a fluid to the die at a pressure of $40~\mathrm{kg/cm^2}$ or less.
 - 5. The die cleaning method according to any one of claims 1 to 4, wherein the die includes a member constituted of cemented carbide.

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6. The die cleaning method according to any one of claims 1 to 5, wherein the die includes a member having

slits.